

TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

2SC4322

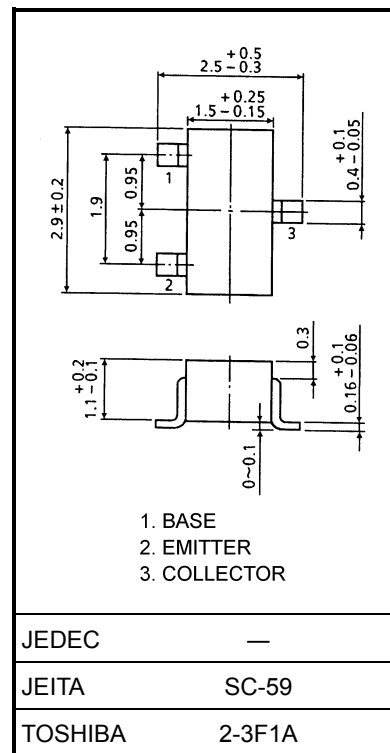
VHF~UHF Band Low Noise Amplifier Applications

Unit: mm

- Low noise figure, high gain.
- $NF = 1.8\text{dB}$, $|S_{21e}|^2 = 7.5\text{dB}$ ($f = 2\text{ GHz}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V_{CBO}	20	V
Collector-emitter voltage	V_{CEO}	10	V
Emitter-base voltage	V_{EBO}	1.5	V
Base current	I_B	7	mA
Collector current	I_C	15	mA
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	125	$^\circ\text{C}$
Storage temperature range	T_{stg}	$-55\sim 125$	$^\circ\text{C}$

Microwave Characteristics ($T_a = 25^\circ\text{C}$)

Weight: 0.012 g (typ.)

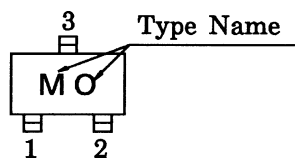
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Transition frequency	f_T	$V_{CE} = 6\text{ V}$, $I_C = 7\text{ mA}$	7	10	—	GHz
Insertion gain	$ S_{21e} ^2 (1)$	$V_{CE} = 6\text{ V}$, $I_C = 7\text{ mA}$, $f = 1\text{ GHz}$	—	13	—	dB
	$ S_{21e} ^2 (2)$	$V_{CE} = 6\text{ V}$, $I_C = 7\text{ mA}$, $f = 2\text{ GHz}$	4.5	7.5	—	
Noise figure	NF (1)	$V_{CE} = 6\text{ V}$, $I_C = 3\text{ mA}$, $f = 1\text{ GHz}$	—	1.4	—	dB
	NF (2)	$V_{CE} = 6\text{ V}$, $I_C = 3\text{ mA}$, $f = 2\text{ GHz}$	—	1.8	3.0	

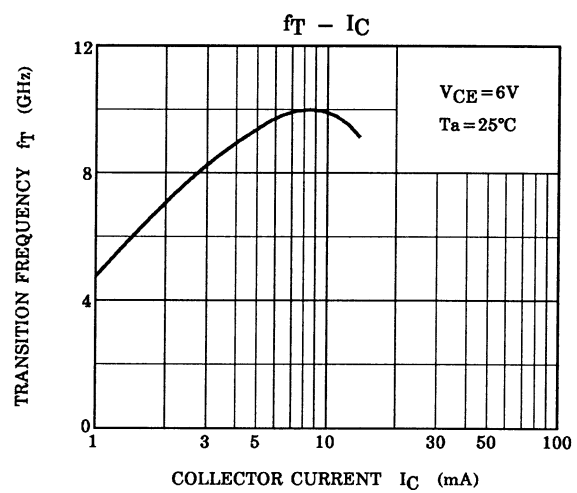
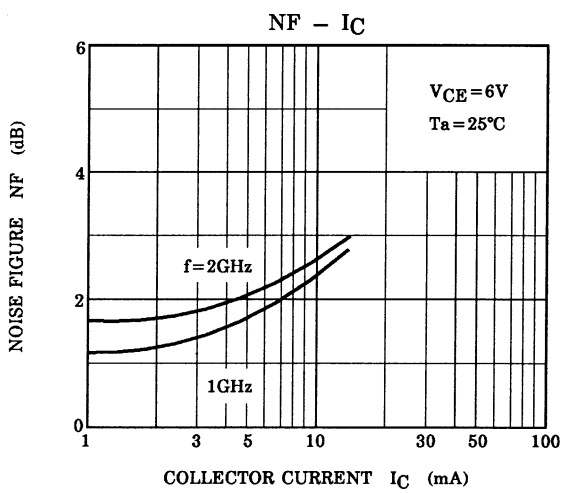
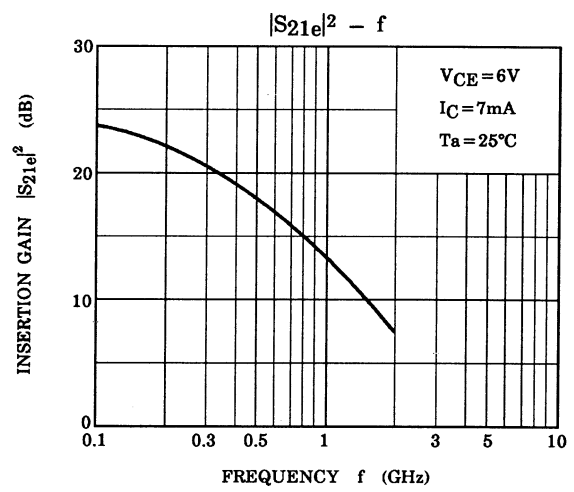
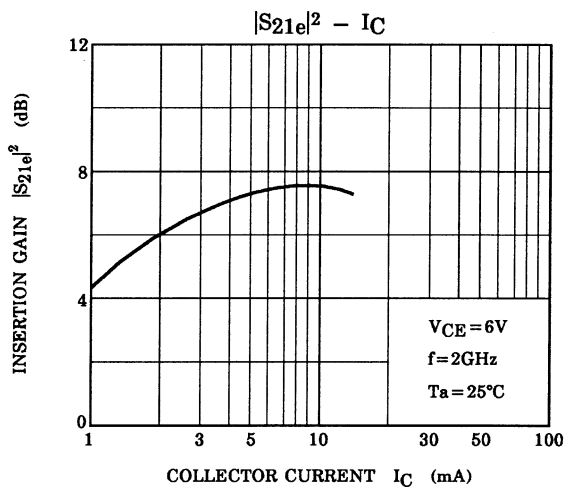
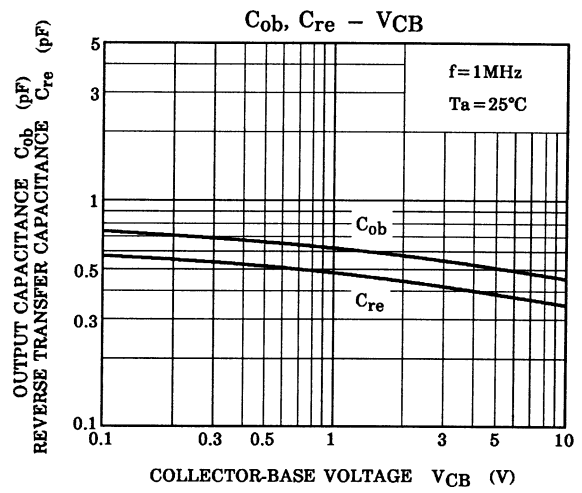
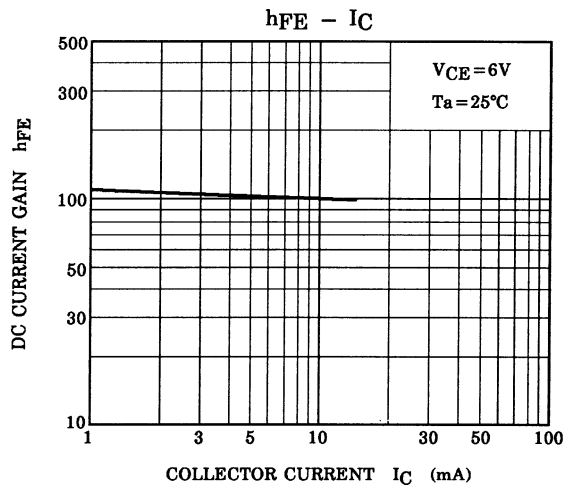
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

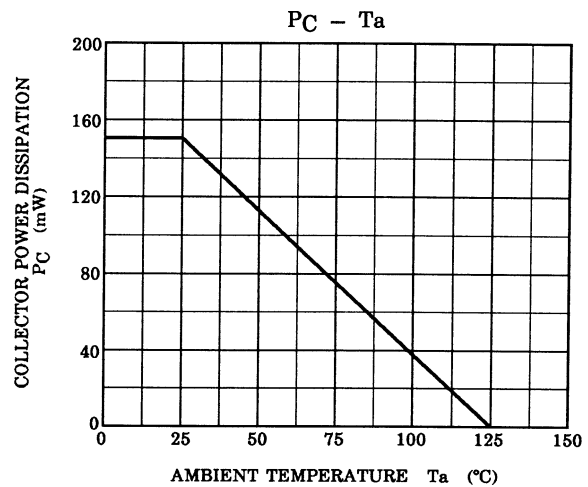
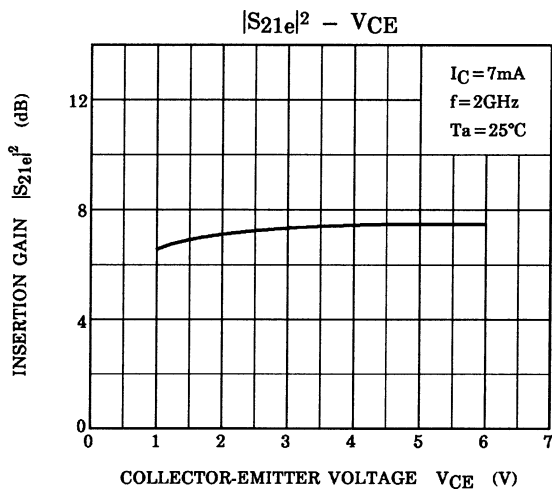
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	I_{CBO}	$V_{CB} = 10\text{ V}$, $I_E = 0$	—	—	1	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = 1\text{ V}$, $I_C = 0$	—	—	1	μA
DC current gain	h_{FE}	$V_{CE} = 6\text{ V}$, $I_C = 7\text{ mA}$	50	—	250	
Output capacitance	C_{ob}	$V_{CB} = 10\text{ V}$, $I_E = 0$, $f = 1\text{ MHz}$ (Note)	—	0.45	—	pF
Reverse transfer capacitance	C_{re}		—	0.35	0.8	pF

Note: C_{re} is measured by 3 terminal method with capacitance bridge.

Marking







S-Parameter $Z_0 = 50 \Omega$, $T_a = 25^\circ\text{C}$

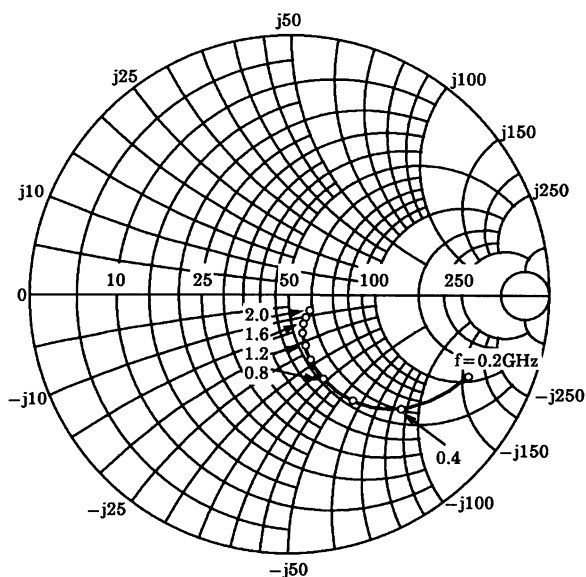
$V_{CE} = 6\text{ V}$, $I_C = 3\text{ mA}$

Frequency	S11		S21		S12		S22	
MHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
200	0.764	−25.0	7.758	153.8	0.037	76.2	0.934	−16.4
400	0.613	−44.9	6.493	132.9	0.065	67.0	0.808	−27.7
600	0.473	−57.9	5.331	117.9	0.085	62.8	0.702	−34.3
800	0.356	−66.9	4.433	106.2	0.102	61.2	0.623	−38.0
1000	0.261	−70.4	3.738	97.7	0.117	60.4	0.575	−40.6
1200	0.198	−71.7	3.266	90.1	0.132	60.2	0.544	−42.4
1400	0.147	−66.3	2.853	83.0	0.147	60.1	0.529	−44.1
1600	0.129	−54.9	2.555	78.2	0.163	60.3	0.519	−46.4
1800	0.114	−41.8	2.348	72.8	0.179	60.0	0.514	−49.0
2000	0.124	−34.5	2.108	69.2	0.192	60.1	0.513	−52.4

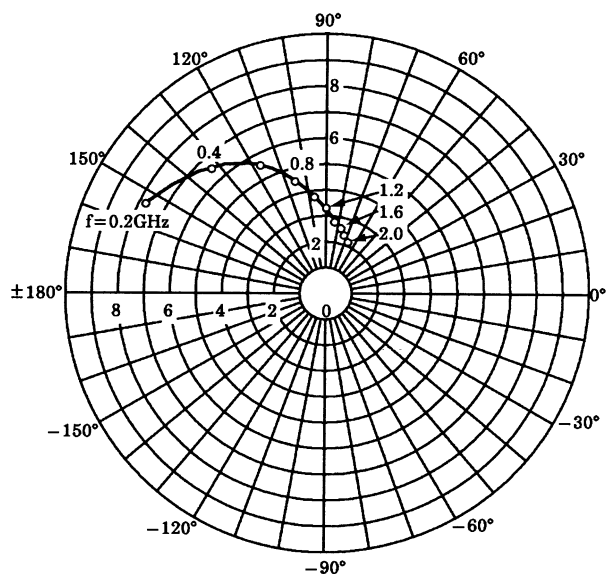
$V_{CE} = 6\text{ V}$, $I_C = 7\text{ mA}$

Frequency	S11		S21		S12		S22	
MHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
200	0.560	−35.3	12.525	142.0	0.032	74.2	0.853	−21.5
400	0.367	−54.1	8.958	118.8	0.055	69.5	0.678	−30.1
600	0.248	−63.4	6.693	105.3	0.073	68.4	0.581	−32.7
800	0.158	−62.4	5.270	95.5	0.091	68.6	0.530	−33.6
1000	0.101	−47.8	4.319	88.5	0.110	68.4	0.506	−34.7
1200	0.088	−27.3	3.687	82.1	0.128	67.9	0.493	−36.0
1400	0.099	−4.3	3.188	76.2	0.146	67.0	0.491	−37.8
1600	0.131	−0.7	2.813	71.9	0.165	66.2	0.492	−40.5
1800	0.152	0.4	2.563	67.4	0.183	65.2	0.498	−43.7
2000	0.167	−1.7	2.276	64.5	0.198	64.5	0.500	−47.5

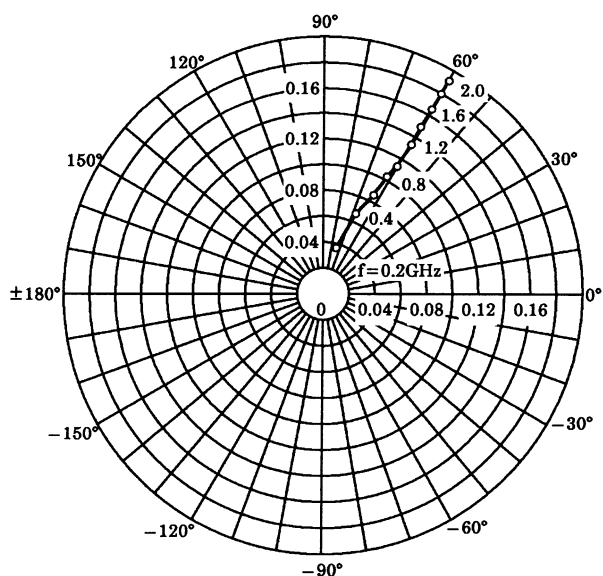
S_{11e}
 $V_{CE} = 6V$
 $I_C = 3mA$
 $T_a = 25^\circ C$
 (UNIT : Ω)



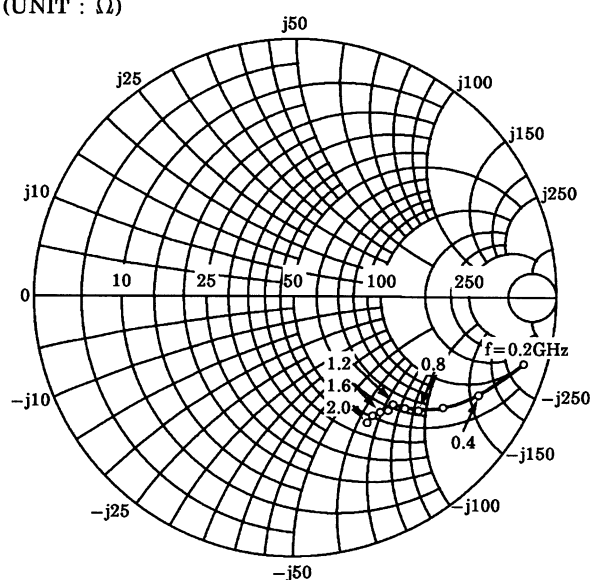
S_{21e}
 $V_{CE} = 6V$
 $I_C = 3mA$
 $T_a = 25^\circ C$



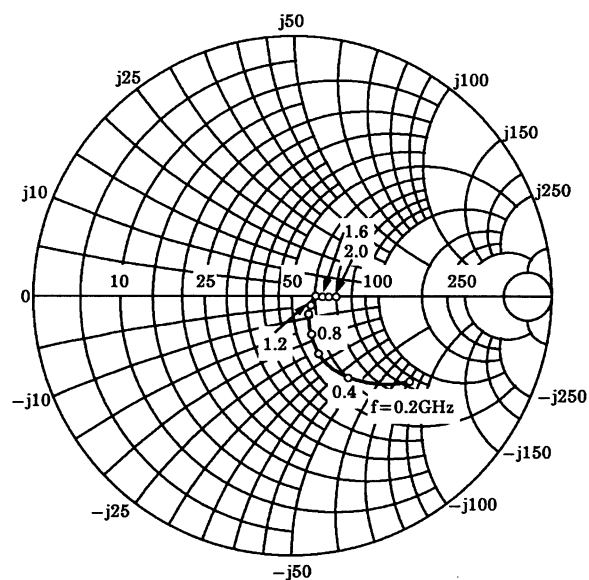
S_{12e}
 $V_{CE} = 6V$
 $I_C = 3mA$
 $T_a = 25^\circ C$



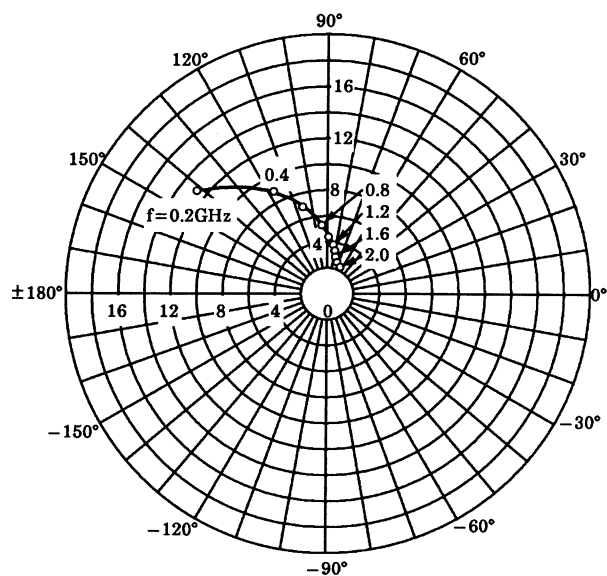
S_{22e}
 $V_{CE} = 6V$
 $I_C = 3mA$
 $T_a = 25^\circ C$
 (UNIT : Ω)



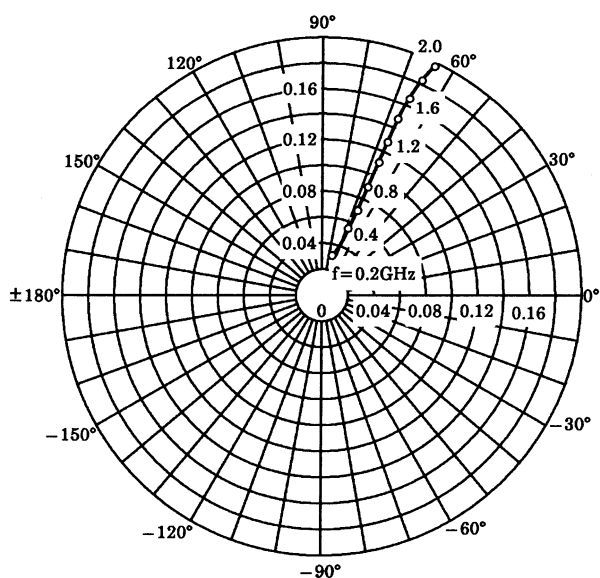
S_{11e}
 $V_{CE}=6V$
 $I_C=7mA$
 $T_a=25^\circ C$
 (UNIT : Ω)



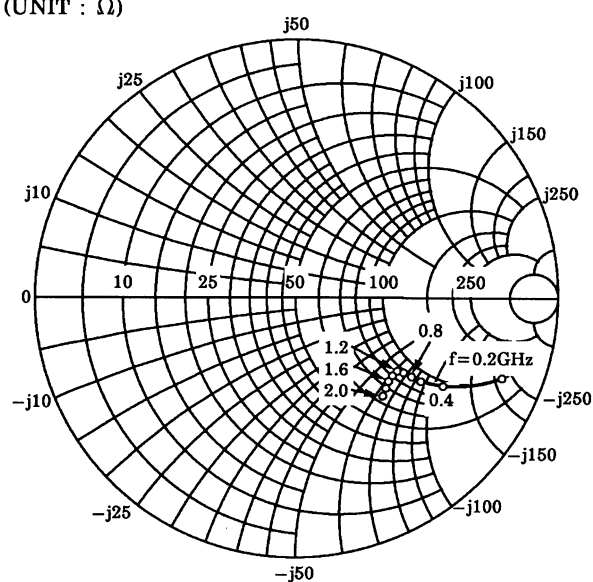
S_{21e}
 $V_{CE}=6V$
 $I_C=7mA$
 $T_a=25^\circ C$



S_{12e}
 $V_{CE}=6V$
 $I_C=7mA$
 $T_a=25^\circ C$



S_{22e}
 $V_{CE}=6V$
 $I_C=7mA$
 $T_a=25^\circ C$
 (UNIT : Ω)



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